



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Yin et al.

Serial No.: 09/293,188

Filed: April 16, 1999

For: METHOD OF FORMING
INTERCONNECT STRUCTURE WITH
INTERLAYER DIELECTRIC (as amended)

Confirmation No.: 4546

Examiner: P. Cao

Group Art Unit: 2814

Attorney Docket No.: 2269-6910.1US
(97-1121.01/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

March 10, 2006
Date


Signature

Leta M. Howard
Name (Type/Print)

AMENDMENT

Mail Stop Amendment
Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Sir:

The following amendments and remarks are filed in response to the Examiner's remarks in the Office Action mailed December 13, 2005, the three-month shortened statutory period for response to which expires on March 13, 2006.

Amendments to the Title appear on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

In the Drawings begins on page 7 of this paper.

Remarks begin on page 8 of this paper.

IN THE TITLE:

The title has been amended herein. Pursuant to 37 C.F.R. §§ 1.121 and 1.125 (as amended to date), please enter the title as amended.

METHOD OF FORMING INTERCONNECT STRUCTURE WITH INTERLAYER
DIELECTRIC